



PRODUCT DATASHEET



- ► Cool White (5700K)

NOW55S46 (3/5 STEP)





APPLICATIONS:

- **General Lighting** •
- **Portable Lighting**
- **Commercial Lighting** •
- Indoor Lighting •
- Backlight for LCD
- Architectural Lighting

RőHS 2835 PLCC2 Series RoHS compliant

FEATURES:

- Package: PLCC2 Top View White Package
- Forward Current: 150mA
- Forward Voltage (typ.): 2.9V
- Luminous Flux (typ.): 65lm@150mA
- Colour: Cool White
- Colour Temperature (CCT): 5700K .
- Viewing angle: 120° •
 - Materials:
 - Die: InGaN _
 - Resin: Silicon (Yellow Diffused) _
 - Finish: Ag plated
- Operating Temperature: -40~+105°C
- Storage Temperature: -40~+100°C
- Electrostatics Discharge: 1000V
 - **Grouping parameters:**
 - **Forward Voltage** _
 - _ Luminous Flux
 - **CIE Chromaticity**
- Soldering methods: Reflow Soldering
- MSL Level: according to J-STD020 Level 3 Packing: 8mm tape with max.16000/reel, ø330mm/13"





CHARACTERISTICS:

Absolute Maximum Characteristics (Ta=25°C, RH=60%)

Parameter	Symbol	Ratings	Unit
DC Forward Current	lf	180	mA
Pulse Forward Current (Duty 1/10, width≤100µS)	Ipf	270	mA
Power Dissipation	PD	576	mW
Reverse Voltage	V _R	5	V
Reverse Current @10V	IR	10	μΑ
Junction Temperature	Tj	120	°C
Electrostatic Discharge	ESD	1000	V
Thermal Resistance (Junction to Solder Point)	Rтнлs	22	°C/W
Operating Temperature	T _{OPR}	-40~+105	°C
Storage Temperature	Тѕтб	-40~+100	°C
Soldering Temperature	T _{SOL}	230 or 260 for 10S	°C

Electrical & Optical Characteristics (Ta=25°C, RH=60%)

Deremeter	Sumbol	Values			l loit	Test	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition	
Forward Voltage	VF	2.8		3.2	V	I _F =150mA	
Luminous Flux	Φv	60	65	75	lm	I _F =150mA	
Chromaticity Coordinates	х		0.3348			I⊧=150mA	
	Y		0.3491				
Colour Temperature	ССТ		5700		к	I⊧=150mA	
Colour Rendering Index	CRI	90	92			l⊧=150mA	
Viewing Angle	20 _{1/2}		120		deg	l⊧=150mA	

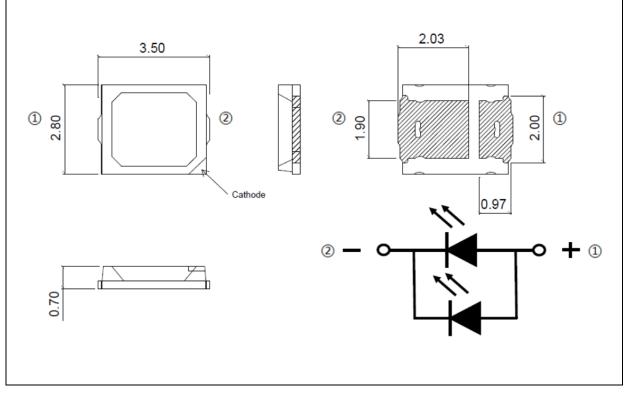
1. Luminous flux (Φ_V) ±10%, Forward Voltage (V_F) ±0.1V

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OUTLINE DIMENSION:

Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.2mm, unless otherwise noted.



BINNING GROUPS:

Code	Min.	Max.	Unit	
B1	2.8	2.9		
C1	2.9	3.0	V	
D1	3.0	3.1	V	
E1	3.1	3.2		

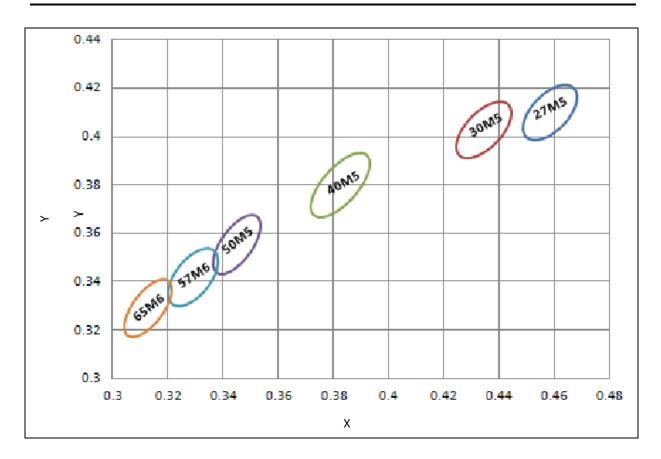
Forward Voltage Classifications (I_F = 150mA):

Luminous Flux Classifications (I_F = 150mA):

			Unit
15	60	65	
1T	65	70	lm
1W	70	75	



CIE CHROMATICITY DIAGRAM:

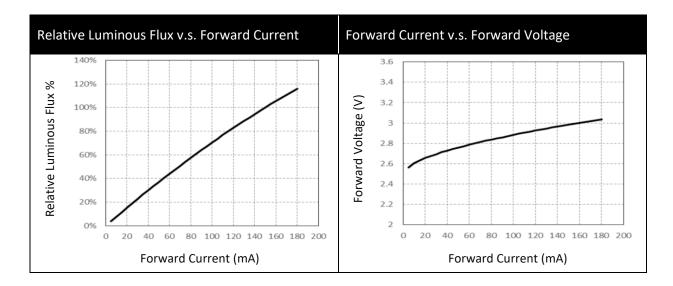


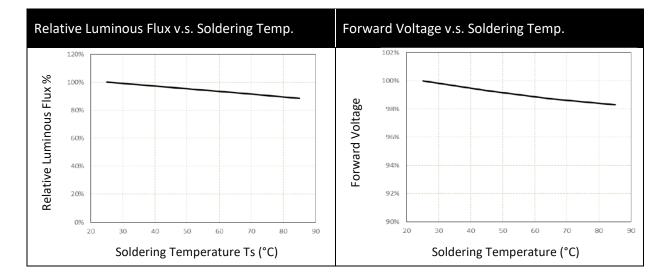
Chromaticity Coordinates Classifications (I_F = 150mA):

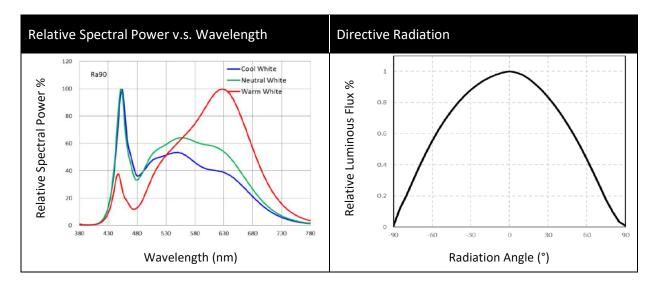
	Code	Centre		Radius		Angle
a		Х	Y	а	b	Φ
	57R5	0.3348	0.3491	0.011175	0.005500	58.35



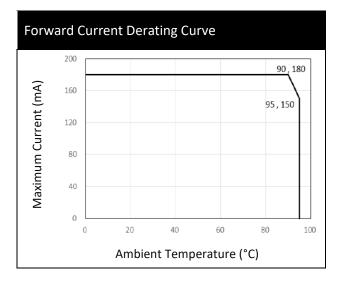
ELECTRO-OPTICAL CHARACTERISTICS:





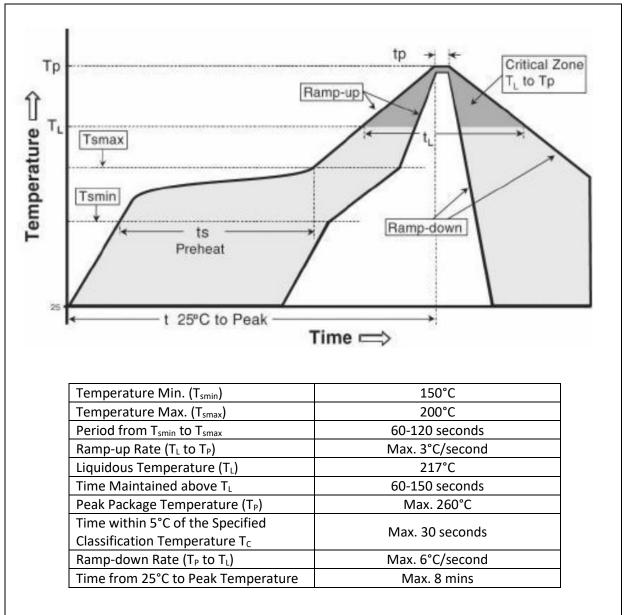








RECOMMENDED SOLDERING PROFILE:



Reflow Lead-free Solder:

Note:

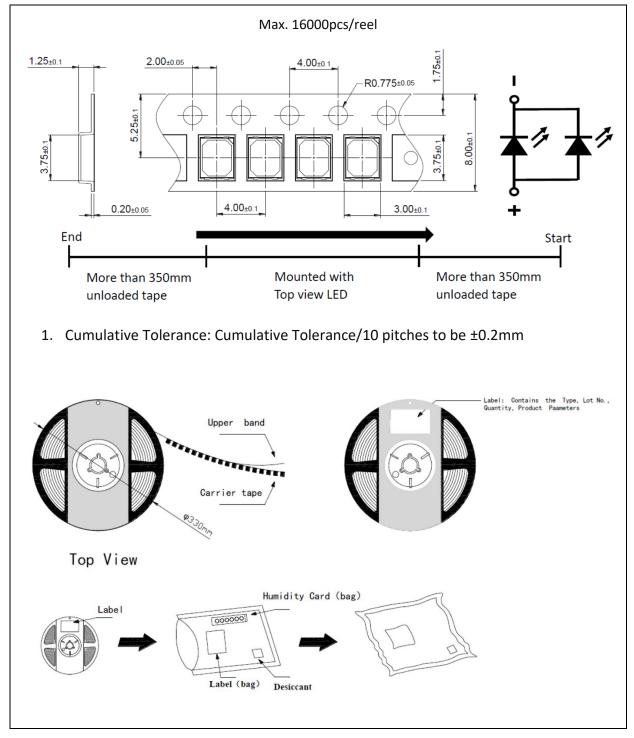
- 1. Maximum reflow soldering: 2 times.
- 2. Before, during, and after soldering, should not apply stress on the components and PCB board.
- 3. Recommended soldering temperature: 230°C. The maximum soldering temperature should be limited to 260°C for max. 10seconds.

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PACKING SPECIFICATION:

Reel Dimension:



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PRECAUTIONS OF USE:



Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent <10% R.H. and apply baking.

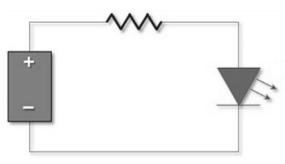
Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

• 60±5°C x 24hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, worktables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



REVISION RECORD:

Version	Date	Summary of Revision
A1.0	21/01/2021	Datasheet set-up.
A1.1	07/04/2021	New datasheet format.
A1.2	08/12/2021	Revised ESD level.
A1.3	30/12/2022	Update working temperature maximum.